

60137-046 H 149-3122-U Jh

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Brown

Group Art Unit:

1732

Serial No.:

10/087,676

Examiner:

Staicovici, Stefan

Filed:

March 1, 2002

Title:

OPEN MOLD MULTI-LAP MANUFACTURING PROCESS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## **AMENDMENT**

Dear Sir:

This paper is responsive to the Office Action mailed on 08-12-2004. Please amend the application in the following particulars.

## **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail, postage prepaid, in an envelope addressed to Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 29<sup>th</sup> day of October, 2004.

Beth A. Beard

11/03/2004 FFANAIA2 00000017 501482 10087676

01 FC:1202

162.00 DA